

Electronic Patent Application Fee Transmittal

Application Number:	10510848			
Filing Date:	13-Oct-2004			
Title of Invention:	Diamond composite substrate and process for producing the same			
First Named Inventor/Applicant Name:	Kiichi Meguro			
Filer:	Brian K. Seidleck/Lana Marceron			
Attorney Docket Number:	50389-053			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	540	540
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$0 paid	1253	1	1110	1110
Miscellaneous:				
Total in USD (\$)				1650